

March 1998

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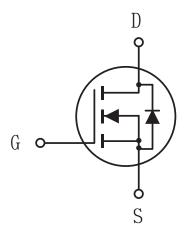
N-Channel Logic Level Enhancement Mode Field Effect Transistor

FEATURES

- 30V , 25A , RDS (ON) = $22m\Omega$ @VGS=10V. RDS (ON) = $40m\Omega$ @VGS=4.5V.
- Super high dense cell design for extremely low RDS(ON).
- High power and current handling capability.
- T0-220 & T0-263 package.







ABSOLUTE MAXIMUM RATINGS (Tc=25°C unless otherwise noted)

| Parameter | Symbol | Limit | Unit |
|---|----------|------------|------|
| Drain-Source Voltage | VDS | 30 | V |
| Gate-Source Voltage | VGS | ±20 | V |
| Drain Current-Continuous @Tj=125°C -Pulsed | ID | 25 | A |
| | IDM | 100 | A |
| Drain-Source Diode Forward Current | Is | 25 | A |
| Maximum Power Dissipation @Tc=25°C | PD | 60 | W |
| Derate above 25°C | | 0.4 | W/°C |
| Operating and StorageTemperature Range | TJ, TSTG | -65 to 175 | °C |

THERMAL CHARACTERISTICS

| Thermal Resistance, Junction-to-Case | R ⊕ JC | 2.5 | °C/W |
|---|--------|------|------|
| Thermal Resistance, Junction-to-Ambient | R θ JA | 62.5 | °C/W |

ELECTRICAL CHARACTERISTICS (Tc=25°C unless otherwise noted)

| Parameter | Symbol | Condition | Min | Тур | Max | Unit | | |
|--------------------------------------|----------------------------|---|-----|-----|------|------|--|--|
| OFF CHARACTERISTICS | | | | | | | | |
| Drain-Source Breakdown Voltage | BVdss | $V_{GS} = 0V$, $ID = 250\mu A$ | 30 | | | V | | |
| Zero Gate Voltage Drain Current | Idss | VDS = 24V, VGS = OV | | | 10 | μA | | |
| Gate-Body Leakage | IGSS | Vgs =±20V, Vds = 0V | | | ±100 | nA | | |
| ON CHARACTERISTICS ^a | | | - | | | | | |
| Gate Threshold Voltage | VGS(th) | V _{DS} = V _{GS} , I _D = 250μA | 1 | 1.6 | 3 | V | | |
| Drain-Source On-State Resistance | Dng (out) | Vgs = 10V, ID = 25A | | 17 | 22 | mΩ | | |
| | RDS(ON) - | Vgs = 4.5V, ID = 10A | | 27 | 40 | mΩ | | |
| On-State Drain Current | ID(ON) | Vgs = 10V, VDs = 10V | 60 | | | A | | |
| Forward Transconductance | g _{FS} | VDS = 10V, ID = 25A | | 35 | | S | | |
| DYNAMIC CHARACTERISTICS ^b | | | • | • | | | | |
| Input Capacitance | Ciss | Vac -15V Vac - AV | | 772 | | PF | | |
| Output Capacitance | Coss | V _{DS} =15V, V _{GS} = OV f =1.0MHz | | 334 | | PF | | |
| Reverse Transfer Capacitance | Crss | 1 10 0000 | | 98 | | PF | | |
| SWITCHING CHARACTERISTICS | b | | | | | | | |
| Turn-On Delay Time | tD(ON) | V _{DD} = 15V, | | 20 | 23 | ns | | |
| Rise Time | tr | Ip = 25A, Vgs = 10V, | | 70 | 110 | ns | | |
| Turn-Off Delay Time | tD(OFF) | $R_{GEN} = 24 \Omega$ | | 90 | 150 | ns | | |
| Fall Time | tf | | | 85 | 130 | ns | | |
| Total Gate Charge | Qg | V 40V V 251 | | 20 | 25 | nC | | |
| Gate-Source Charge | Qgs | V _{DS} =10V, I _D = 25A, V _{GS} =10V | | 3 | | nC | | |
| Gate-Drain Charge | \mathbb{Q}_{gd} | . 45 | | 6 | | nC | | |

ELECTRICAL CHARACTERISTICS (Tc=25°C unless otherwise noted)

| Parameter | Symbol | Condition | Min | Тур | Max | Unit | |
|---|--------|-------------------|-----|-----|-----|------|--|
| DRAIN-SOURCE DIODE CHARACTERISTICS ^a | | | | | | | |
| Diode Forward Voltage | Vsd | Vgs = 0V, Is =25A | | 0.9 | 1.3 | ٧ | |

Notes

- a.Pulse Test:Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.
- b.Guaranteed by design, not subject to production testing.

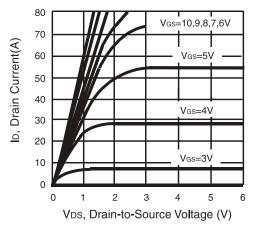


Figure 1. Output Characteristics

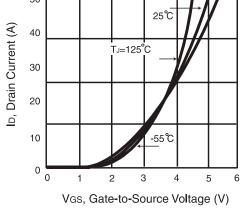


Figure 2. Transfer Characteristics

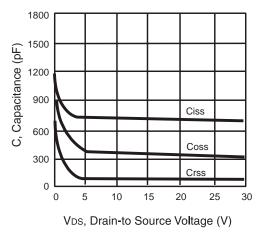


Figure 3. Capacitance

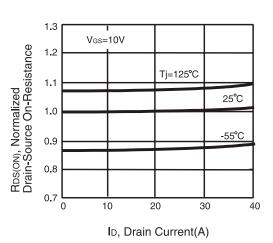
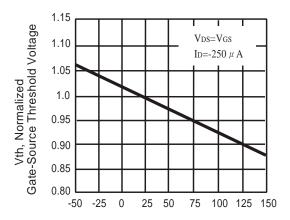


Figure 4. On-Resistance Variation with Drain Current and Temperature

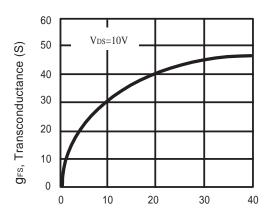
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Tj, Junction Temperature (°C)

Figure 5. Gate Threshold Variation with Temperature



IDS, Drain-Source Current (A)

Figure 7. Transconductance Variation with Drain Current

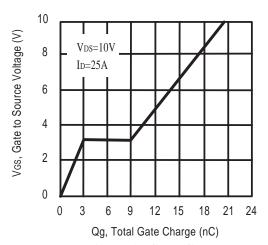
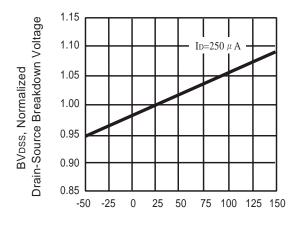
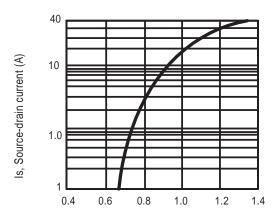


Figure 9. Gate Charge



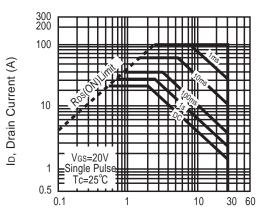
Tj, Junction Temperature (°C)

Figure 6. Breakdown Voltage Variation with Temperature



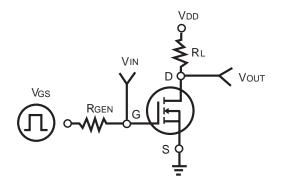
Vsp, Body Diode Forward Voltage (V)

Figure 8. Body Diode Forward Voltage Variation with Source Current



VDS, Drain-Source Voltage (V)

Figure 10. Maximum Safe Operating Area



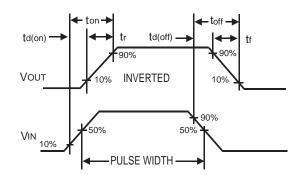


Figure 11. Switching Test Circuit

Figure 12. Switching Waveforms

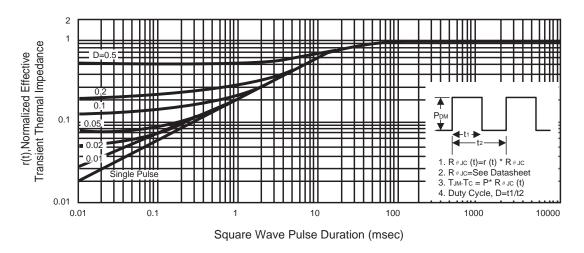


Figure 13. Normalized Thermal Transient Impedance Curve